



RECOMMENDED PCB LAYOUT

X ±	X* ± 1*
.X ± 0.10	.X* ± 0.5*
.XX ± 0.05	.XX* ±
.XXX ±	.XXX* ±

UNITS	MM	NAME (INTENDED USE)	
MAT'L		PART NO. (INTENDED USE)	
FINISH		APPD:	
QTY		CHKD:	
		DRWN: N. Doanue	9/23/97
TITLE:		PART NO. TRXB092DKHN-T330/T26	
SULLINS ELECTRONICS CORP		SCALE NONE	
		SHEET 1 OF 1	
		REV A	

PLASTIC POST - T330

**MATERIAL**  
 INSULATOR: GLASS-REINFORCED THERMOPLASTIC,  
 U194V-0 RATED.  
 CONTACT: COPPER ALLOY.  
 PLATING: MATING AREA- GOLD,  
 SOLDER AREA- TIN/LEAD.

**ELECTRICAL**  
 VOLTAGE RATING: 250 VAC RMS.  
 CURRENT RATING: 3 AMP.  
 INSULATION RESISTANCE: 1,000 MEGOHMS MIN.  
 CONTACT RESISTANCE: 30 MILLIOHMS MAX.

**MECHANICAL**  
 CONTACT RETENTION: 460 GRAMS MIN PER CONTACT.  
 INSERTION FORCE: 230 GRAMS MAX PER CONTACT PAR.  
 WITHDRAWAL FORCE: 15 GRAMS MIN PER CONTACT PAR

**ENVIRONMENTAL**  
 TEMPERATURE RANGE: -55° TO +85°.  
 NO PART MARKINGS

**GOLD PLATING**  
 REPLACE "x" IN THE PART NUMBER:  
 W = SELECTIVE GOLD FLASH  
 Z = SELECTIVE 100μ" GOLD  
 X = SELECTIVE 30μ" GOLD

REV	DESCRIPTION	BY	DATE
A	Added position 1 indicators	BC	06-03-03